

The Enrico Fermi Institute

The DAMIC-M Experiment

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Charge-Coupled Devices

- Non-destructive ionization readout of subkeV energy deposits in bulk silicon (675 microns thick)
- Charges are drifted and collected in 15x15 micron pixels before being read out
- Charges are moved from pixel-to-pixel until readout with low charge transfer inefficiency



J. Tiffenberg et al, Phys. Rev. Lett. 119, 131802 (2017) [arXiv:1706.00028]



- DAMIC@SNOLAB has already demonstrated the capability of fully-depleted silicon CCDs to search for dark matter:
 - A. Aguilar-Arevalo *et al*, Phys. Rev. Lett. 118, 141803 (2017) [arXiv:1607.07410]
- new Skipper CCDs (shown above) allow consecutive non-destructive readout of a single pixel

 \rightarrow sub-electron readout noise



Event Reconstruction

- As charges diffuse across the CCD, they drift apart
- The dispersion of collected charges (σ) carries information about the depth of an event

3166

3164

316

3156

3154

3152

5330

5334 5336 5338 5340 5342 5344 5346 5348

x [pixel]

5330

y [pixe] y 3120

 The distribution of energy over the pixel array tells the event type



5340 5342 5344 5346 5348

x [pixel]

5330

5344 5346 5348

x [pixel]

Diffusion Model for Different Fits

DAMIC-M Sensitivity



DAMIC-M Sensitivity (DM-electron scattering)





Advantages

• <u>Dark current</u>: demonstrated in DAMIC@SNOLAB

0 < 10⁻³ e⁻pix⁻¹day⁻¹ at operating temperature of ~140K

 <u>Background Rejection</u>: isolation of certain radioisotopes by observation of multiple decay chain processes

 Example of a likely ³²Si-³²P coincidence with half life of 14.3 days (below)



A. Aguilar-Arevalo *et al*, JINST 10 (2015) P08014 [arXiv:1506.02562]



- <u>Energy Response</u>: linear down to very low energies (above)
 - Linear within 5% down to 40 eV, or 10 electrons

Challenges - Background Modeling

- Depth (cm) 0.06 0.05 0.04 0.03 0.02 0.01 00
 - DAMIC@SNOLAB acts as an exceptional test-bed for understanding and mitigating background sources
 - We are well underway in producing a complete background model for DAMIC@SNOLAB (stay tuned...)
 - Dominant backgrounds for DAMIC-M expected to come from
 - ³²Si (can be rejected through coincidence with ³²P)

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 Tritium from silicon activation (can be mitigated through shielding during transport/storage)

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Future Prospects

- Design and CCD Manufacturing underway
- Background controls and modeling = progressing
- Construction at Modane begins 2020
- Physics data in 2023

 \odot Goal: 1 kg-year at 0.1 dru background

• **<u>Funded</u>** by ERC and NSF (2018 – 2023)





Established by the European Commission



1. Switching to electroformed copper

→eliminate ²³⁸U, ²³²Th, ²¹⁰Pb contributions

2. Careful handling procedures

 \rightarrow reduced ²¹⁰Pb surface contributions

3. Clean cabling

 \rightarrow reduced ²³⁸U, ²³²Th, and ⁴⁰K contributions

4. Shielding during transport/manufacturing

 \rightarrow Reduced ³H, ²²Na, and Copper activation products

... and more to achieve 0.1 dru